

## LAB MODULE 1: PDMS Device Fabrication

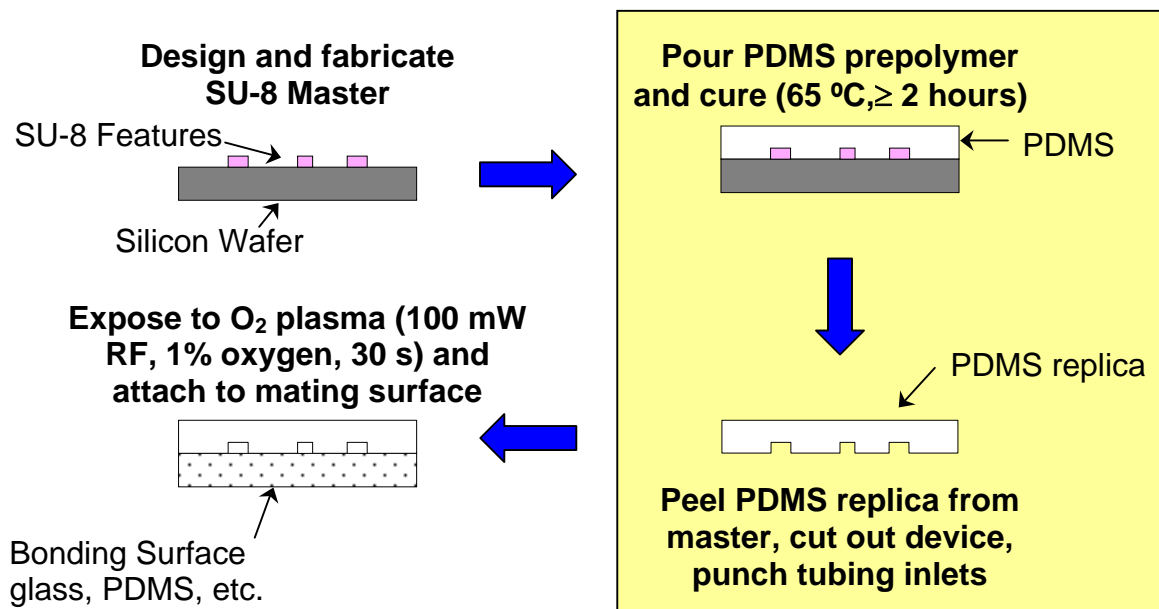
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### Purpose and Expected Outcome:

The purpose of this laboratory module is to provide an introduction and a hands-on demonstration of micro-fabrication of a PDMS device. We will start with a SU-8 master and fabricate devices in PDMS.

### Overview of Polydimethyl Siloxane (PDMS) Device Fabrication:

PDMS device fabrication is one of the easiest methods for the rapid prototyping microfluidic devices. The main steps in fabricating are sketched in Scheme 1 below.



**Scheme 1.** Schematic overview of PDMS Device Fabrication.

In this experimental module, we will perform the steps outlined in the yellow box above. The general principles of microfabrication, including design and manufacture of positive resists, will be covered by Daniel Irimia in the first lecture entitled “Fundamentals of Microfabrication”. The bonding of the elastomer device will be discussed, but will not be carried out due to time and space constraints. Post-bonding surface modification will be covered by Shashi Murthy in the second lecture, “Surface Chemistry and Modification”.

PDMS is a flexible elastomeric polymer that is an excellent material for microfluidic device fabrication.<sup>1</sup> In this lab module, we will use one of the most common PDMS elastomers, Sylgard® 184 from Dow Corning®. Sylgard is a two part resin system containing vinyl groups (part A) and hydrosiloxane groups (part B) shown in Scheme 2 below. Mixing the two resin components together leads to a cross-linked network of dimethyl siloxane groups. Because this



## Module Outline and Workflow:

In this lab module, participants will get hands-on experience casting (pouring) PDMS over a silicon master device. Because PDMS takes > 2 hours to cure, another set of devices will be prepared ahead of time for cutting.

### Protocol

1. PDMS pouring
  - 1.1. Put on a clean pair of gloves, lab coat, and face mask
  - 1.2. Remove the master mold from its protective case and place it in a Petri dish secured by a tape. Blow with the nitrogen gun to remove any dust that may have accumulated.
  - 1.3. On the coarse scale, weigh out and mix 55 g of 1:10 PDMS per master mold into a small hexagonal weigh boat. Do this by first weighing out 5 g of curing agent, and then 50 g of polymer base.
  - 1.4. Mix the pre-cured PDMS with a mixing fork. Be sure to both swirl and fold the mixture to ensure that the curing agent is evenly distributed.
  - 1.5. Pour the PDMS into the SU-8 master mold placed in a Petri dish.
  - 1.6. Degas the PDMS by placing the mixed pre-cured PDMS in the vacuum desiccator and evacuating the chamber. Bubbles will appear, rise to the surface of the mixture, and pop. Degas the mixture for a minimum of 30 min. Vent the chamber as bubbles come close to the surface. Do this 2–3 times for the first 15 min. Degassing is complete when there are no longer bubbles visible in the mixture. Once all bubbles have been removed, cover the Petri dish and place in an oven at 80\_C for 3-6 hrs to cure the PDMS.
2. PDMS release
  - 2.1. Remove the PDMS casting from the oven and place on a clean bench top.
  - 2.2. Using an X-acto knife with a new blade, make straight cuts about 1/4" from the edge of the master mold. To make each cut, sink the point of the knife vertically into the PDMS until it reaches the silicon substrate. Angle the knife approximately 30° to the vertical and drag it in the direction of the cut. Make sure to maintain pressure on the knife such that the tip is always in contact with the silicon substrate. At the end of each cut, continue through the casting tray. Repeat this for each edge of the master mold.
  - 2.3. Once all the edges have been liberated, lift the mold up off the bench-top and carefully peel away the remaining portions of the casting tray from the underside of the mold. Discard this and any excess PDMS.
  - 2.4. Place the released PDMS layer in a clean Petri dish with it feature side up.
3. Fluidic port punching
  - 3.1. Set the stereo microscope at the lowest zoom setting and locate and center the first device you wish to punch holes.
  - 3.2. Center the port you will be punching in the field of view.
  - 3.3. Wipe off the tip of the hole puncher with the ethanol soaked Kimwipe and bring it into alignment with the first port you will punch.
  - 3.4. Adjust the puncher so that it is as vertical as possible. Push the puncher through the PDMS until you hit the bottom.
  - 3.5. With the punched port centered in the field of view, push the puncher in to punched hole to drive out the cored section of PDMS.
  - 3.6. Retrieve and discard the cored section from the under side of the device using a pair of forceps.
  - 3.7. Repeat steps 3.1 to 3.6 for each port.
  - 3.8. Place the punched PDMS device onto a Petri dish with feature side UP

Once the devices have been poured, cut, and punched, we will discuss the process of bonding and surface chemical modification. In our labs, PDMS replicas and glass slides are cleaned with

an oxygen plasma (100 mW, 1% oxygen, 30 s) in a PX-250 plasma chamber (March Instruments, Concord, MA) and then immediately placed in contact to bond the surfaces irreversibly. Chambers are then baked at 70 °C for 10 min following bonding.

### References:

1. McDonald, J. C.; Duffy, D. C.; Anderson, J. R.; Chiu, D. T.; Wu, H.; Schueller, O. J.; Whitesides, G. M., Fabrication of microfluidic systems in poly(dimethylsiloxane). *Electrophoresis* **2000**, 21, (1), 27-40.
2. Makamba, H.; Kim, J. H.; Lim, K.; Park, N.; Hahn, J. H., Surface modification of poly(dimethylsiloxane) microchannels. *Electrophoresis* **2003**, 24, (21), 3607-19.
3. *Silicon Compounds: Silanes and Silicones*. Gelest, Inc.: Morrisville, PA, 2004; p 560.
4. Hermanson, G. T.; Mallia, A. K.; Smith, P. K., *Immobilized Affinity Ligand Techniques*. Academic Press: San Diego, CA, 1992; p 454.

### Sources:

Small Parts, Inc.  
 13980 N.W. 58th Court  
 P.O. Box 4650  
 Miami Lakes, FL 33014-0650  
<http://www.smallparts.com>

Part Description	Usage	Inner Diameter	Outer Diameter	Small Parts Part #
20G x ½” Stainless Steel Blunt Needles	Needles for cutting holes	0.023”	0.036”	NE-201PL-C
22G x ½” Stainless Steel Blunt Needles	Needles for direct injecting	0.016”	0.028”	NE-221PL-C
30G x ½” Stainless Steel Blunt Needles	Needles for tubing	0.006”	0.012”	NE-301PL-C
Tygon Tubing	Connect needles to device	0.01”	0.03”	TGY-010-5C

PDMS – [Dow Corning Sylgard 184](#)